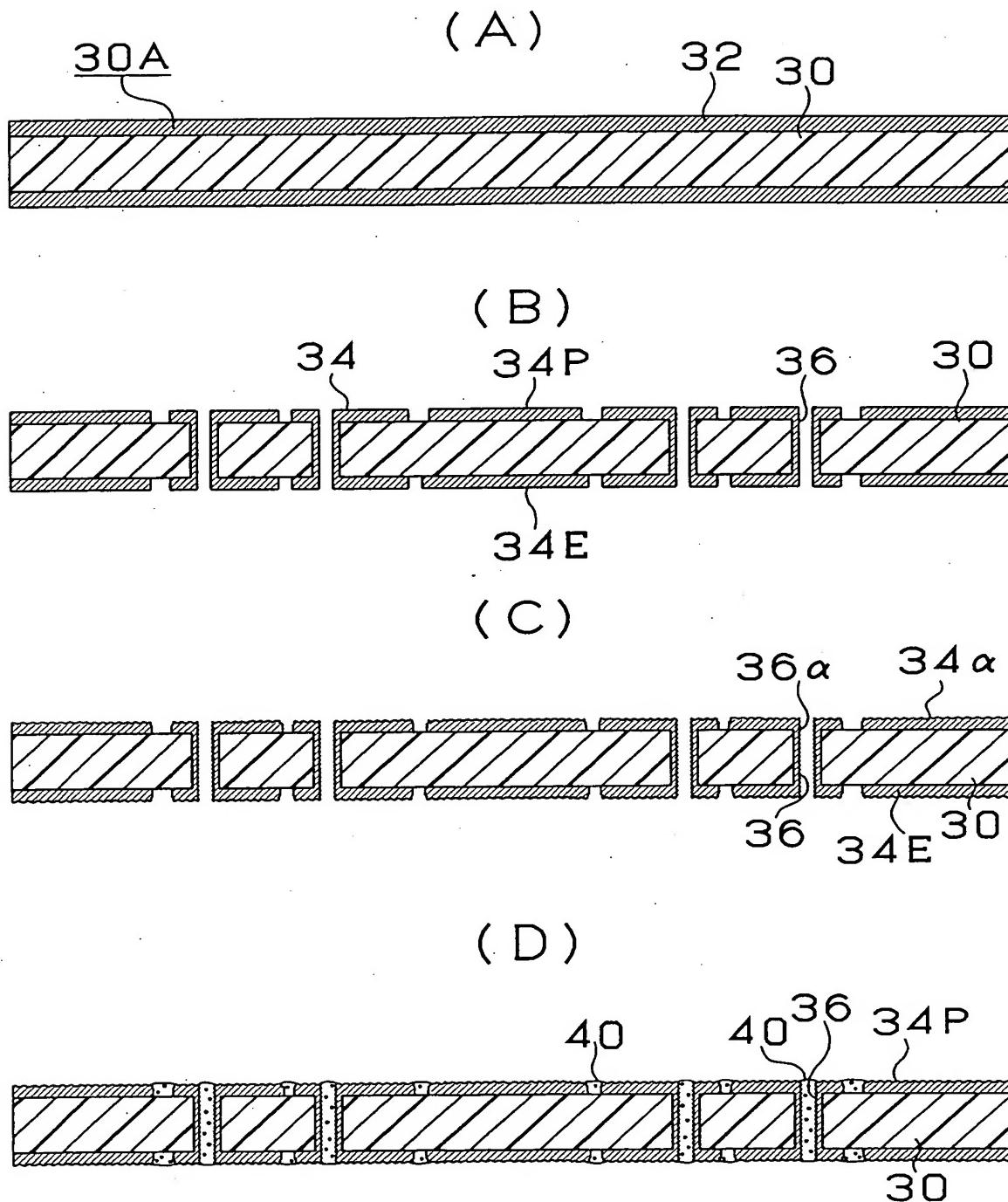


1/29  
Fig. 1

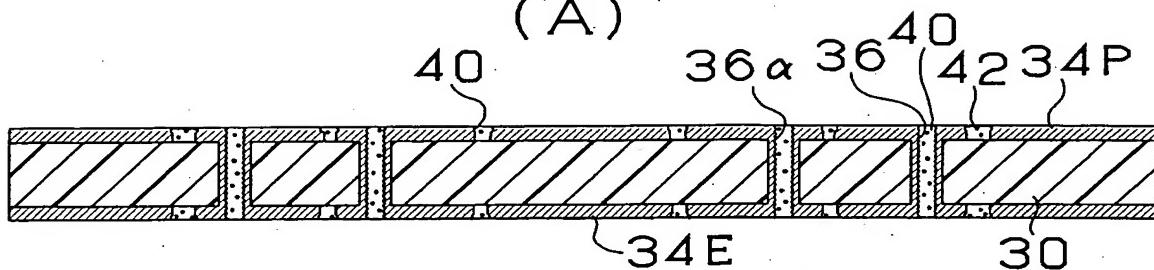


BEST AVAILABLE COPY

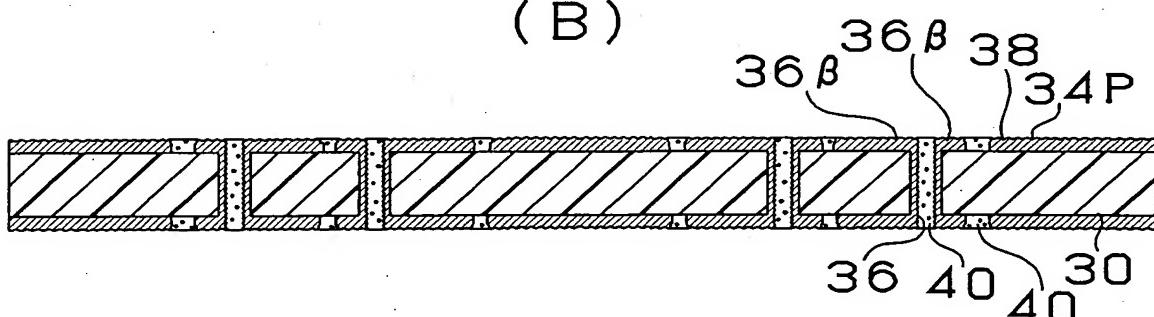
2/29

Fig. 2

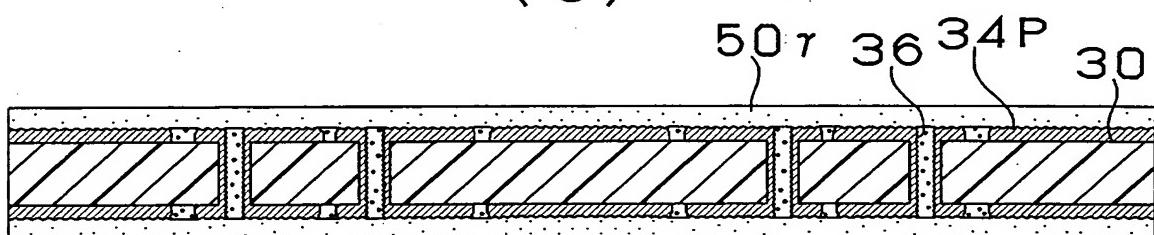
(A)



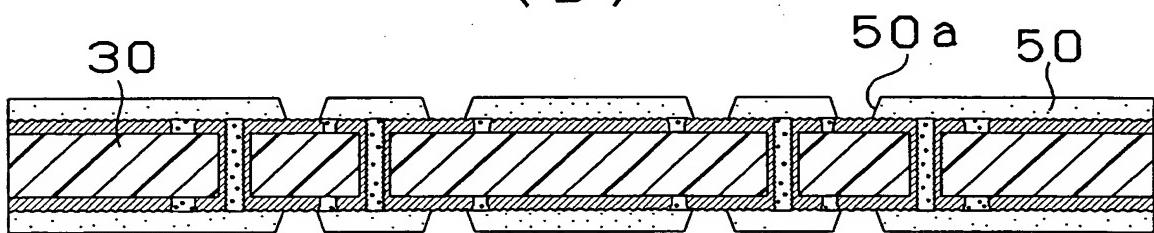
(B)



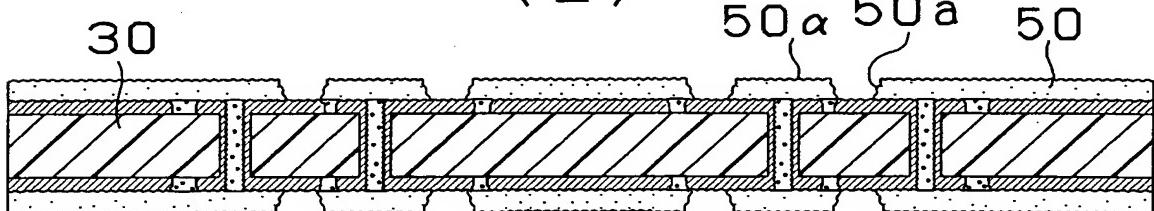
(C)



(D)



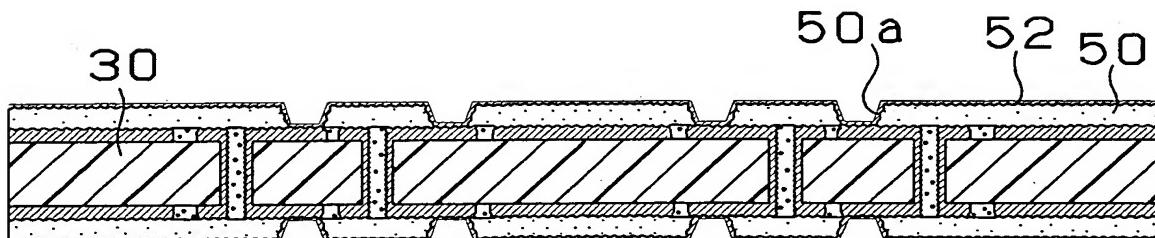
(E)



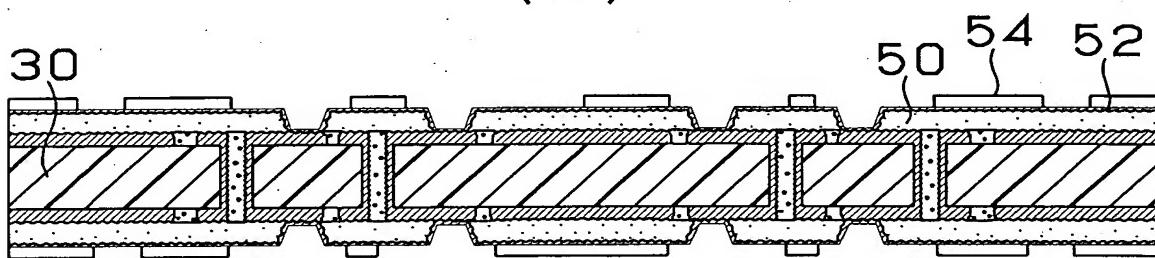
3/29

Fig. 3

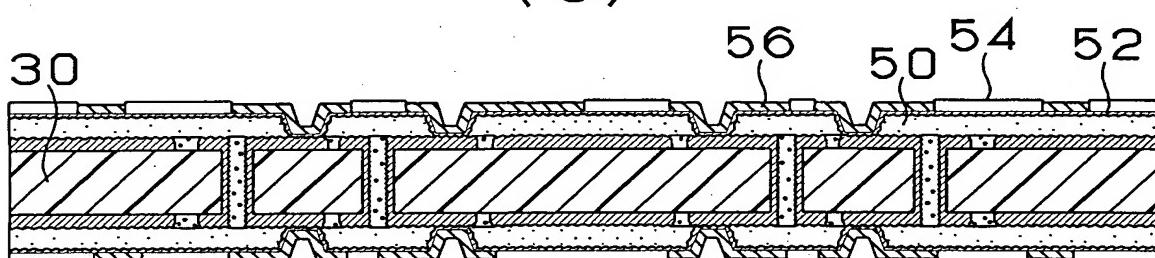
(A)



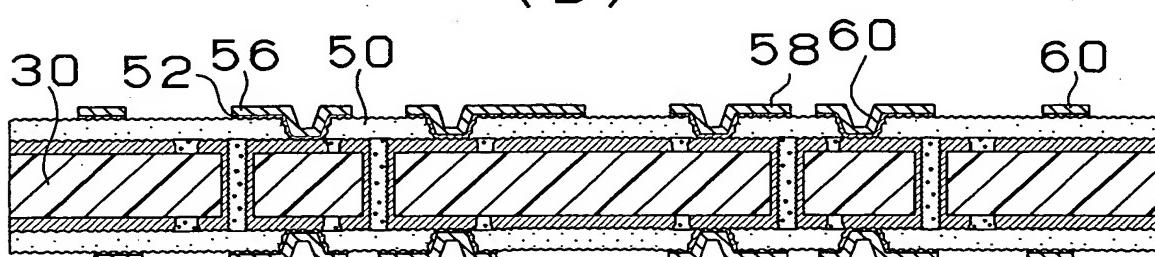
(B)



(C)

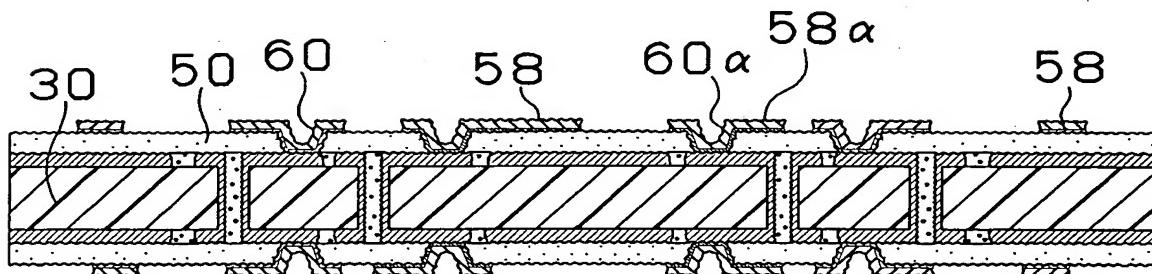


(D)

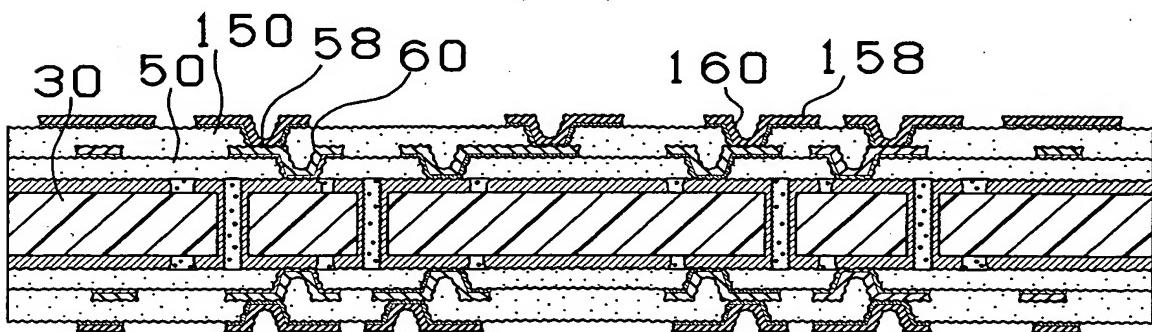


4/29  
Fig. 4

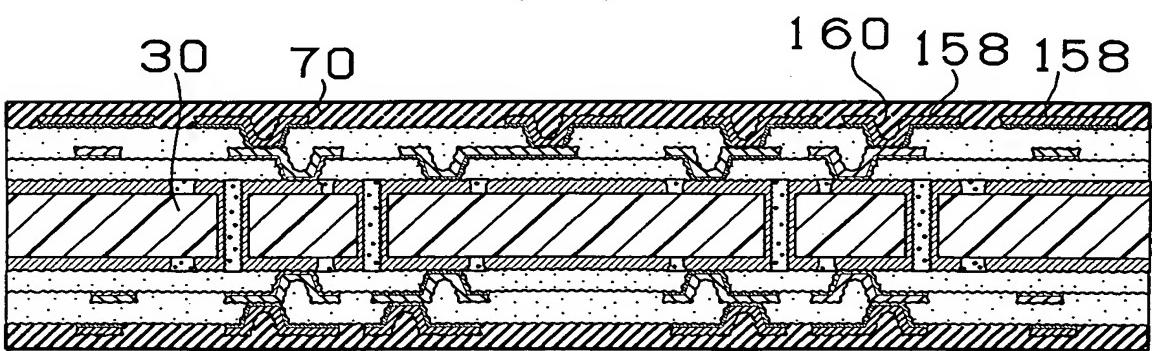
(A)



(B)

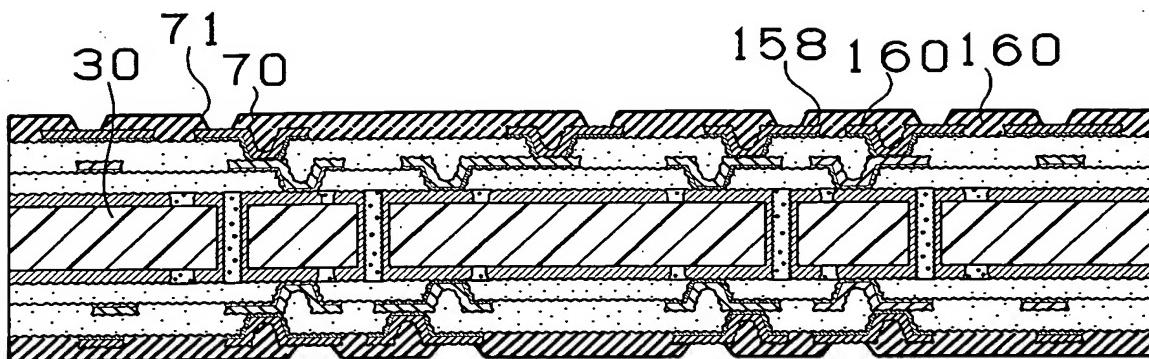


(C)



5/29  
Fig. 5

(A)



(B)

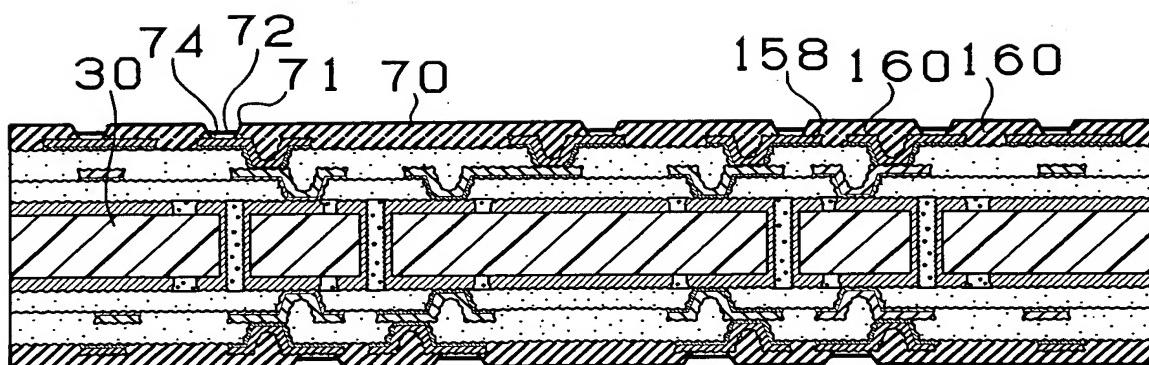


Fig. 6

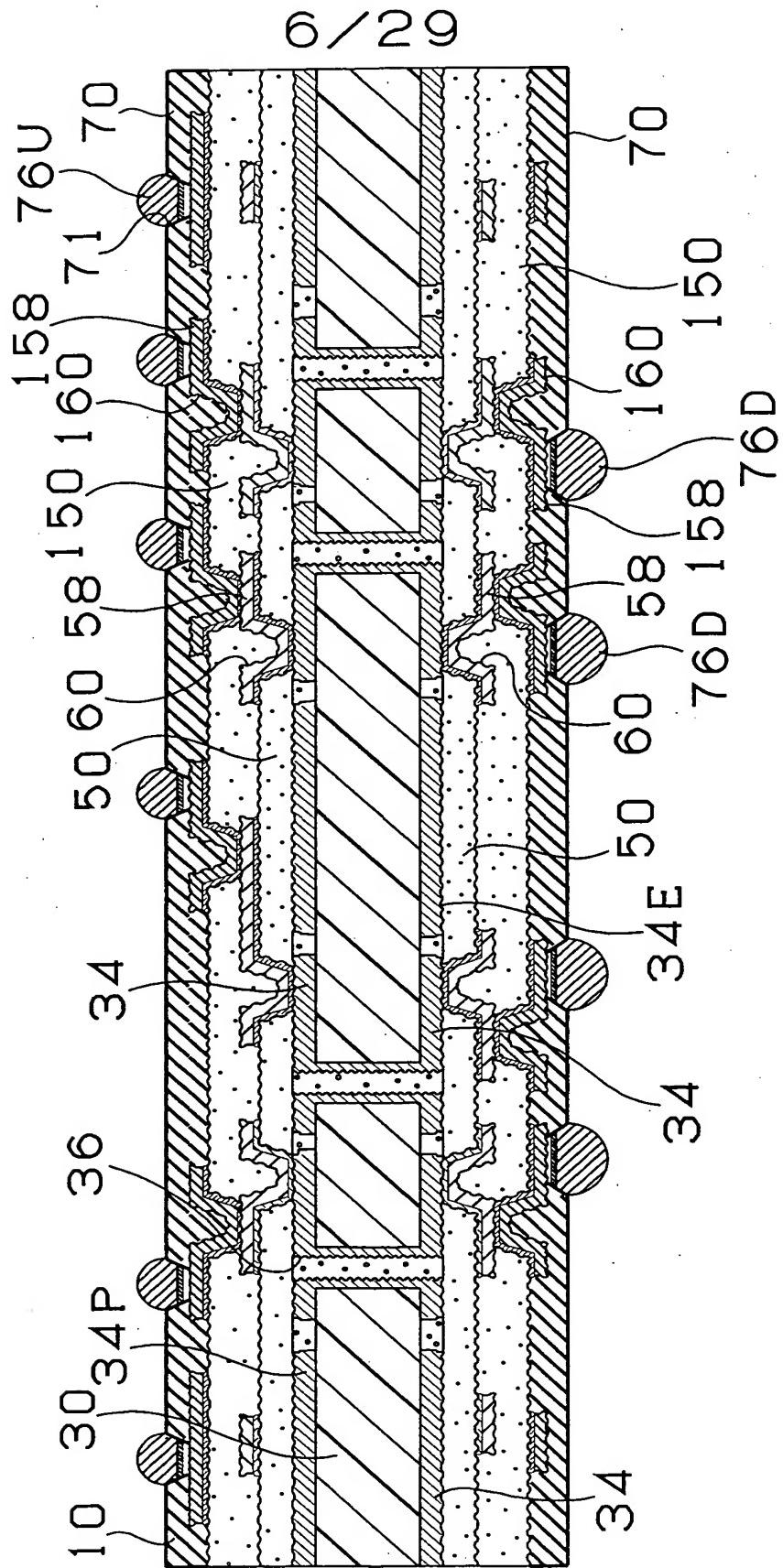
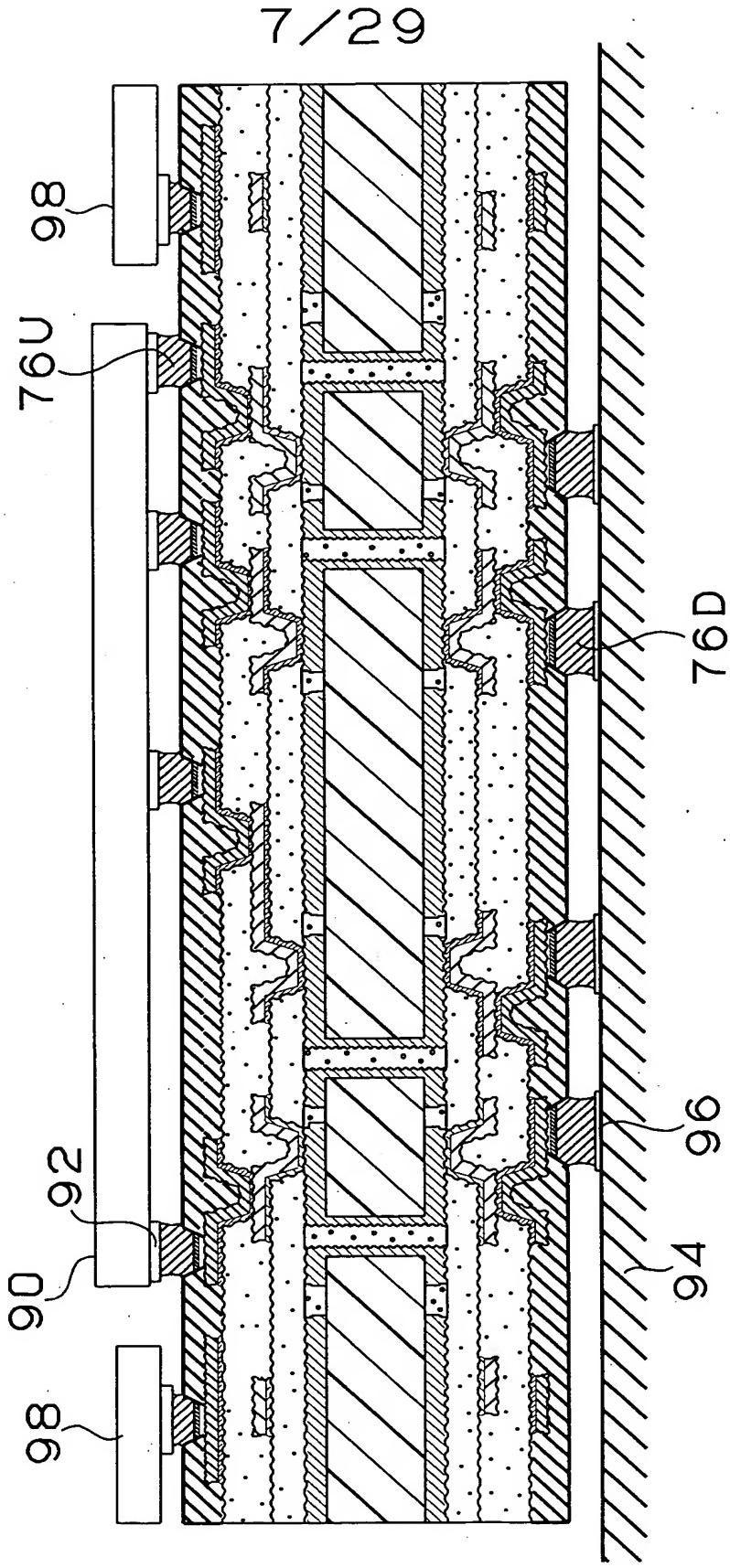
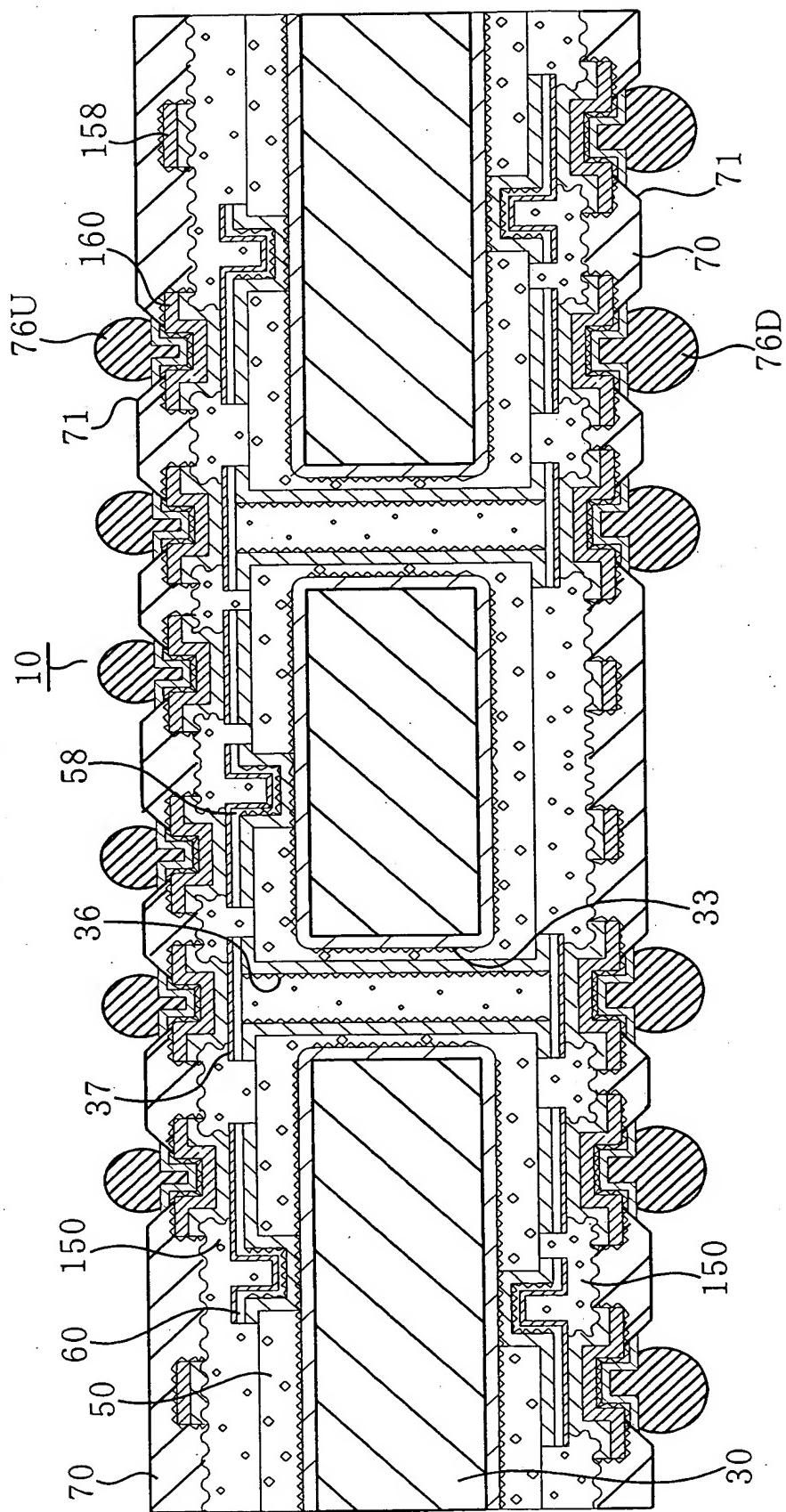


Fig. 7



8 / 29

Fig. 8



9 / 29

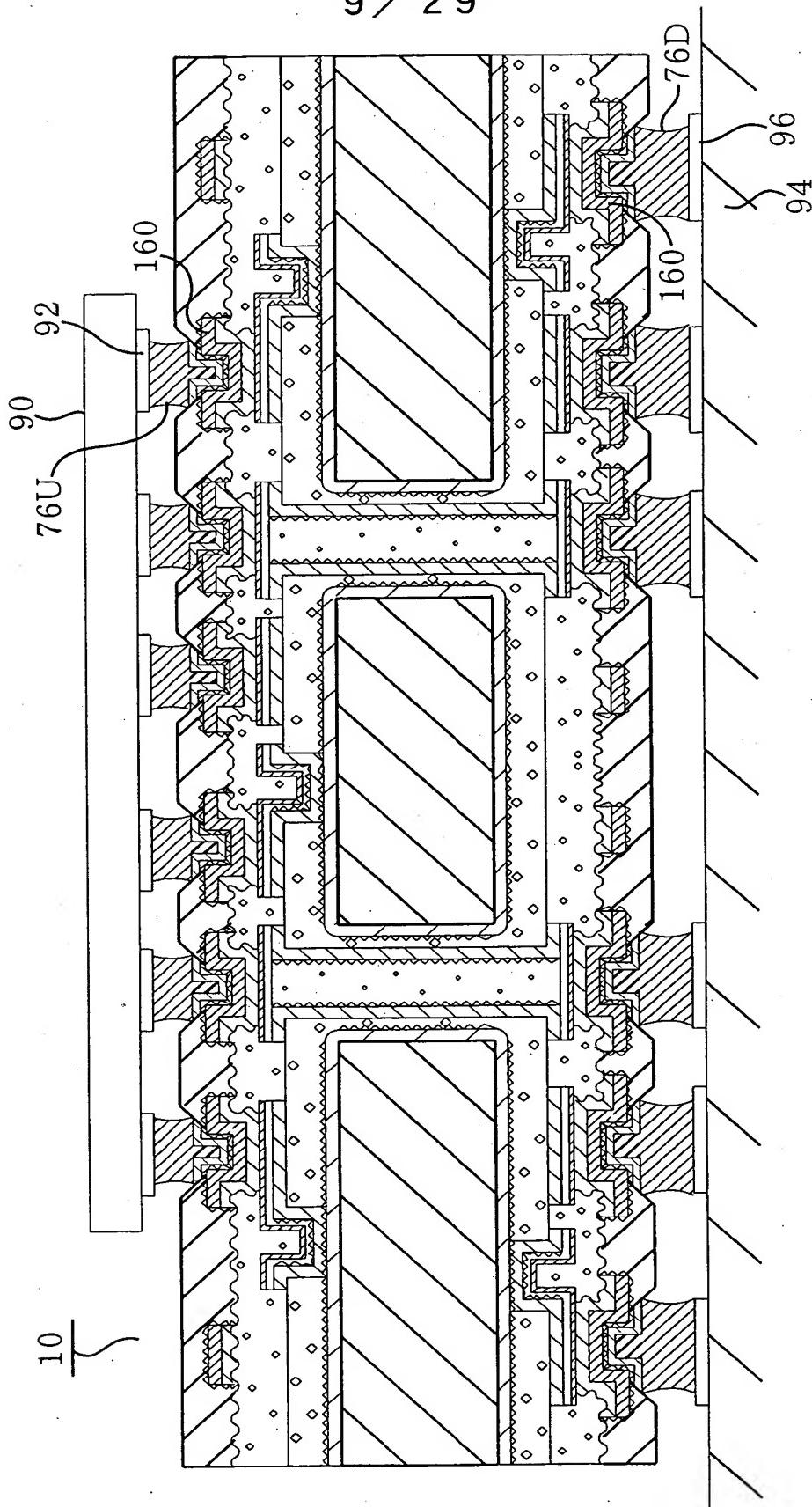


Fig. 9

10/29

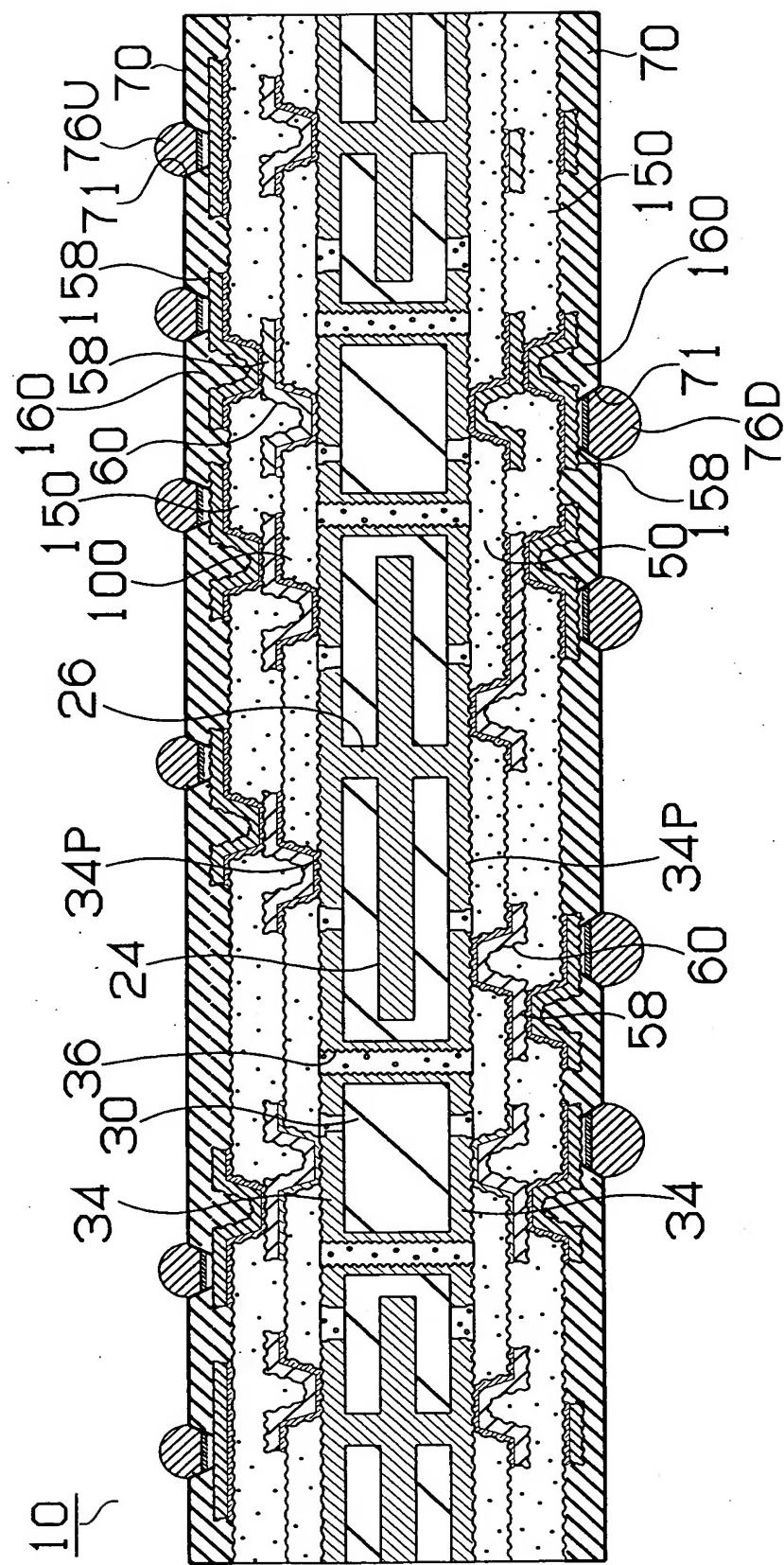
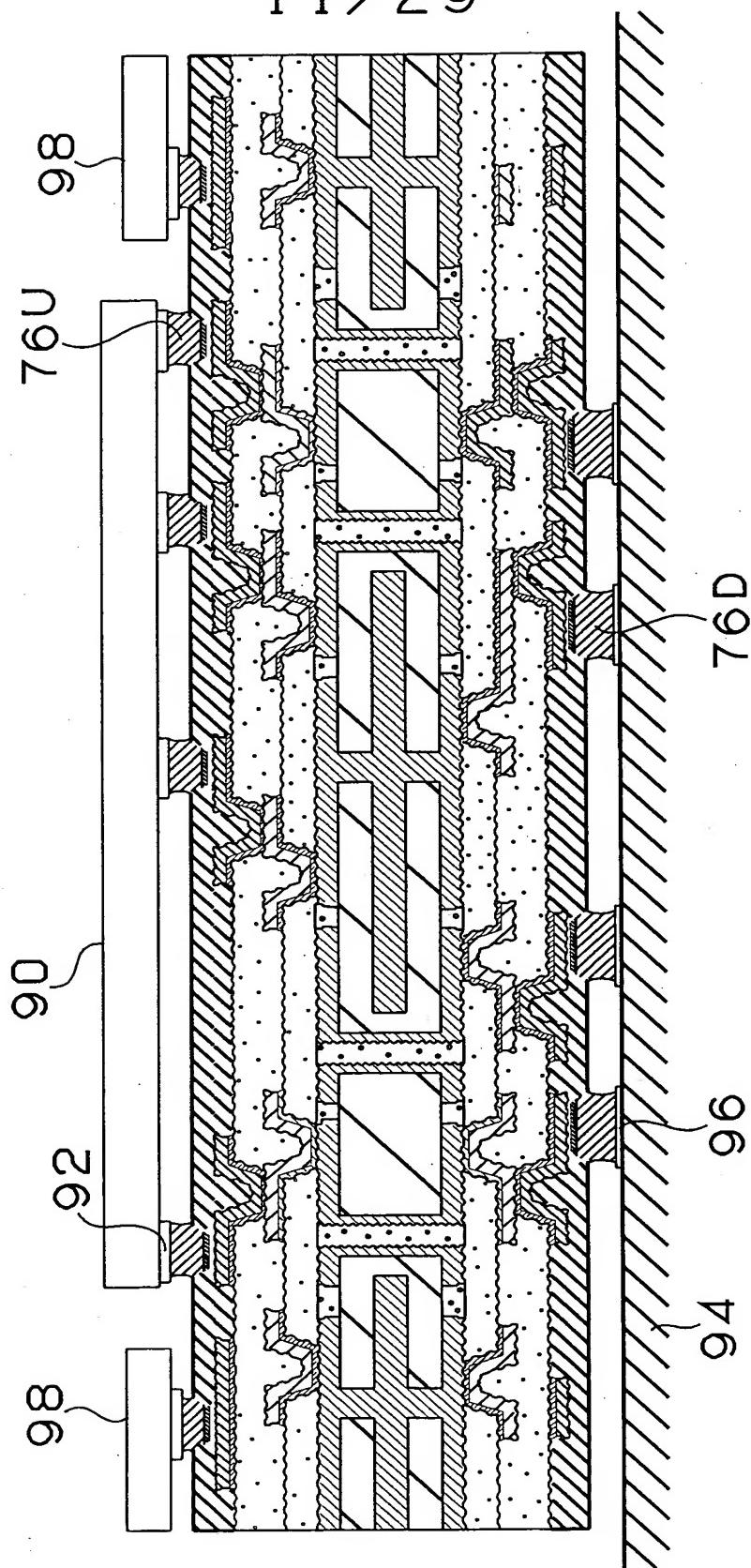


Fig. 10

10  
—

11 / 29

Fig. 11



12/29

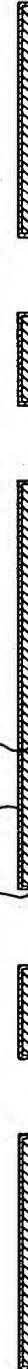
Fig.12  
12 (A)



12a 12 (B)



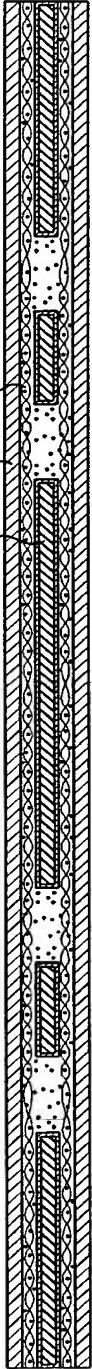
12a 13 12 (C)



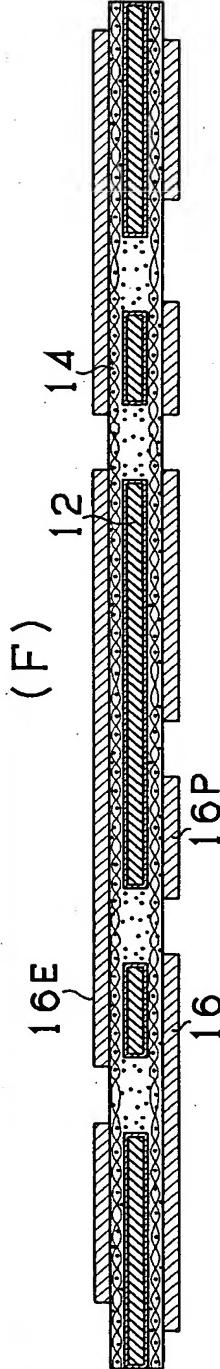
(D)



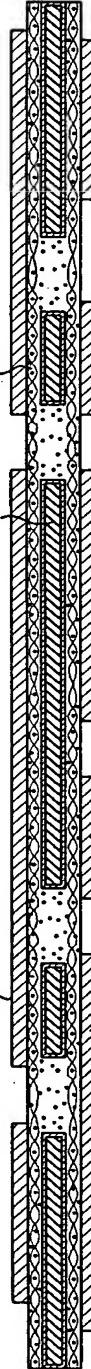
(E) 12 16 14



(F)



16E

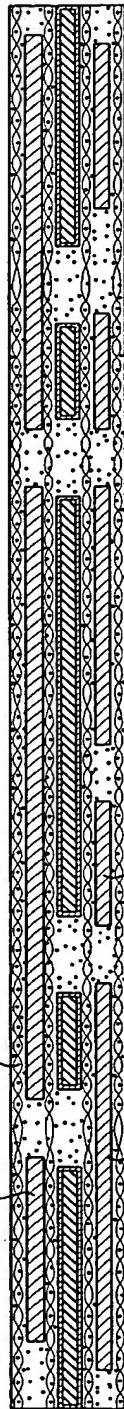


16 16P

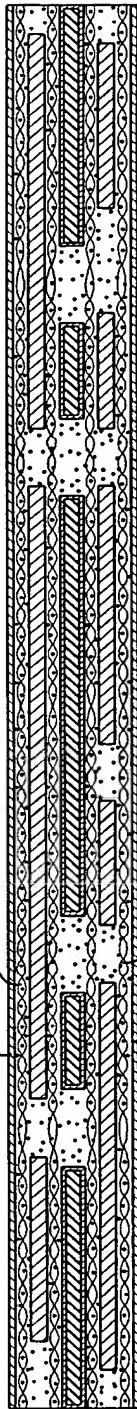
13/29

Fig. 13  
(A)

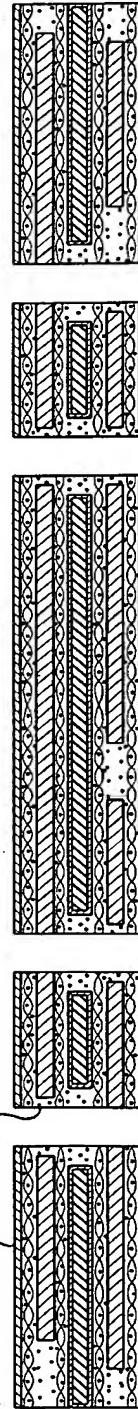
16E 18



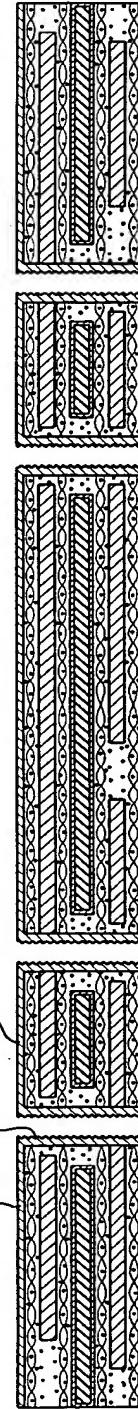
18 16 34a 18 16P (B)



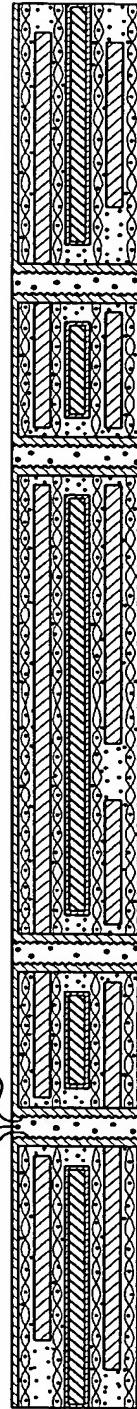
34a 36a 34a 18 (C)



34a 34a 36 22 (D)

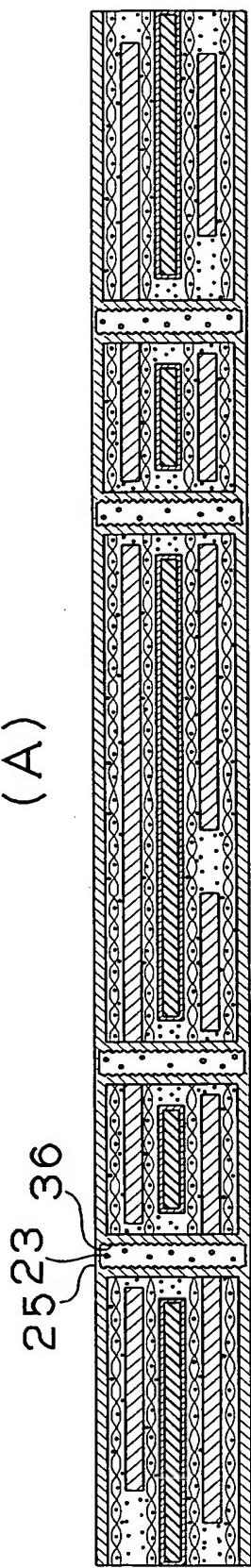


36 23 22 (E)

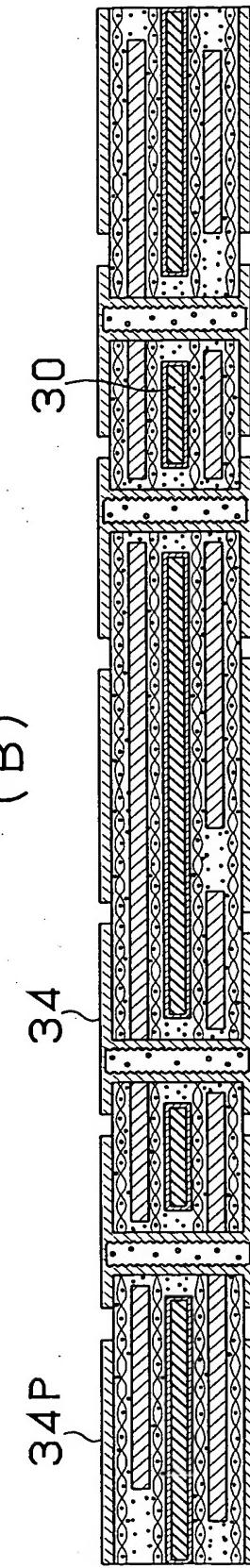


14/29

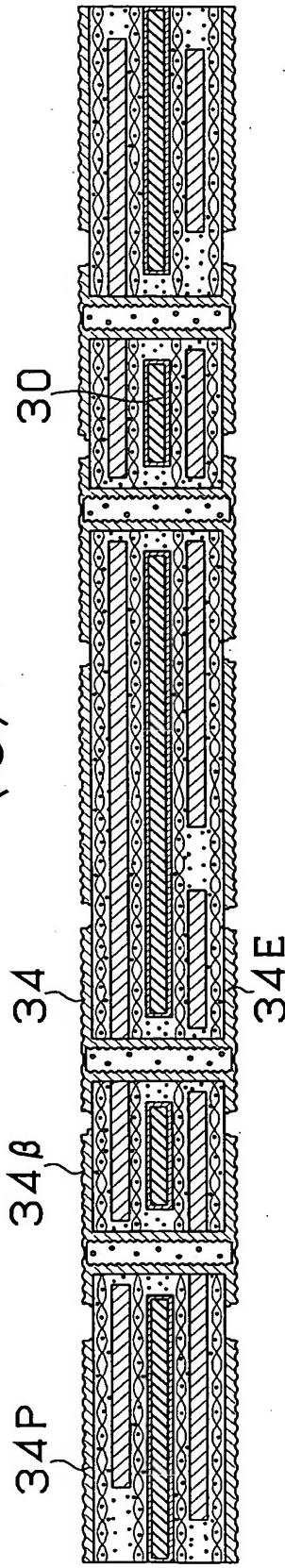
Fig. 14  
(A)



(B)

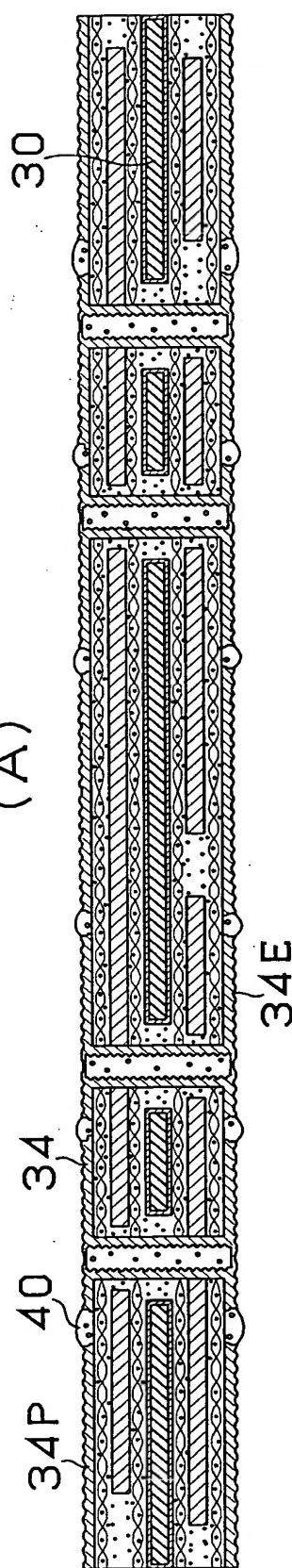


(C)

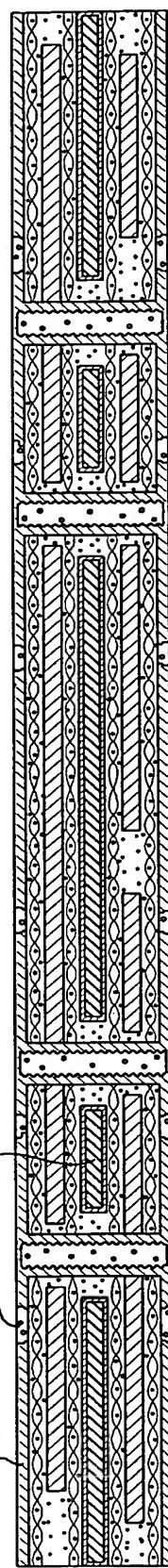


15 / 29

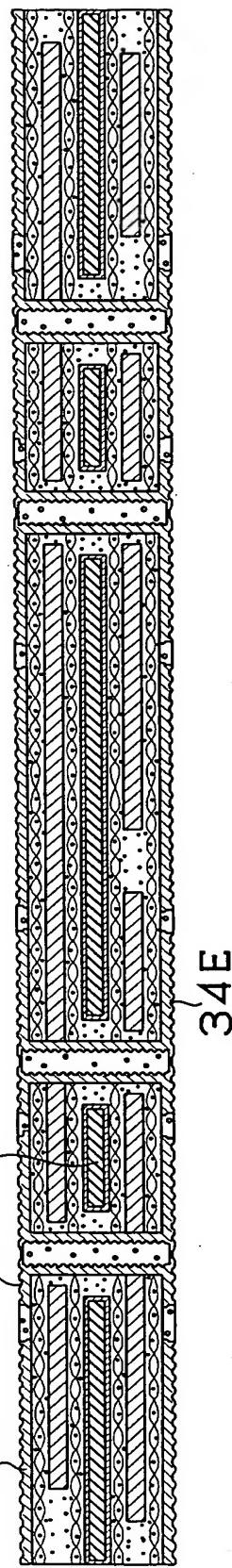
Fig. 15  
(A)



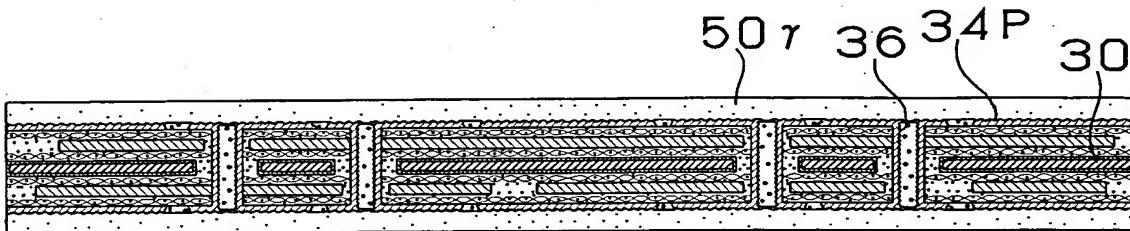
(B)



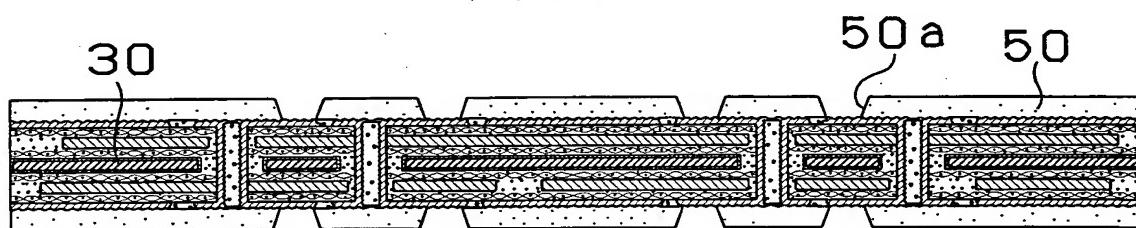
(C)



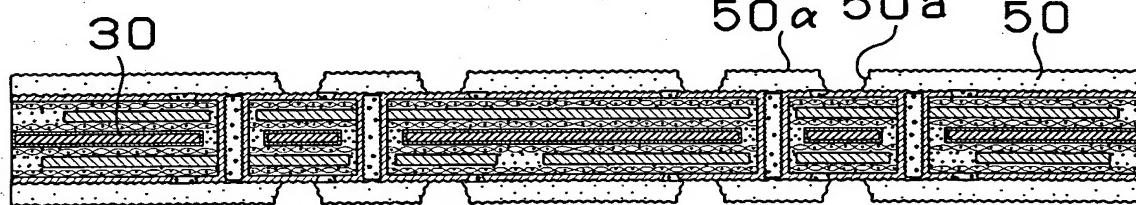
16/29  
Fig. 16  
(A)



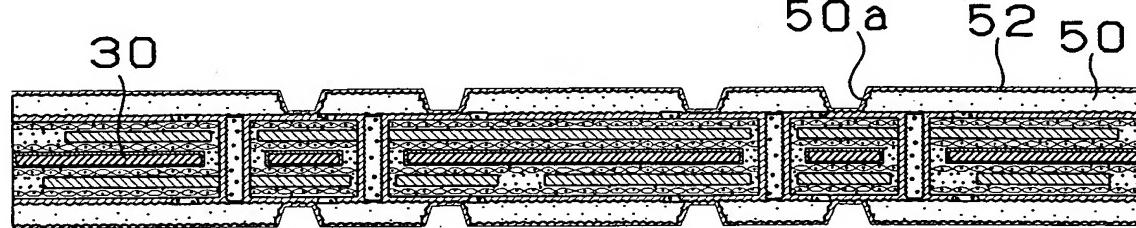
(B)



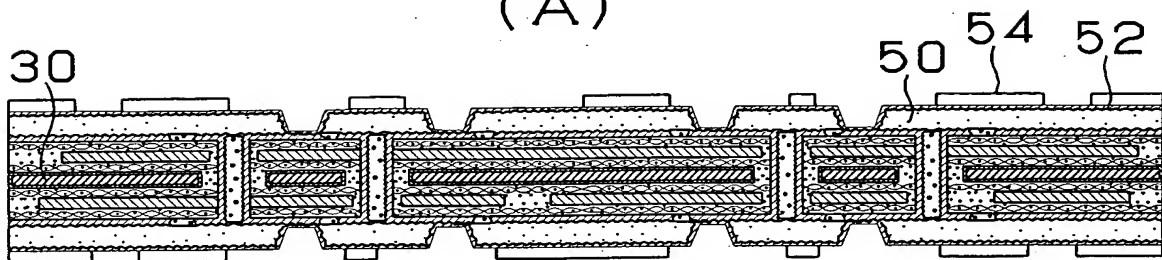
(C)



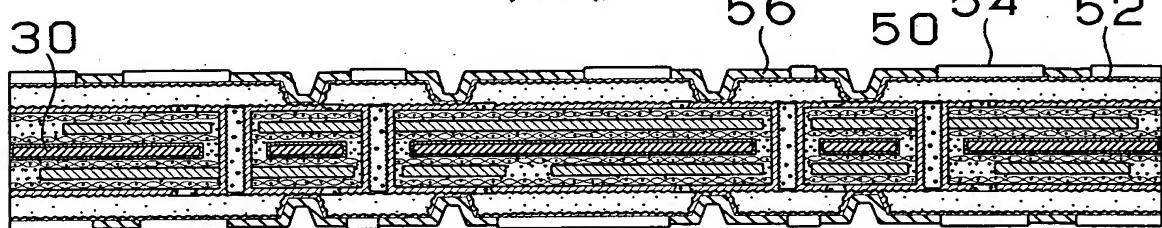
(D)



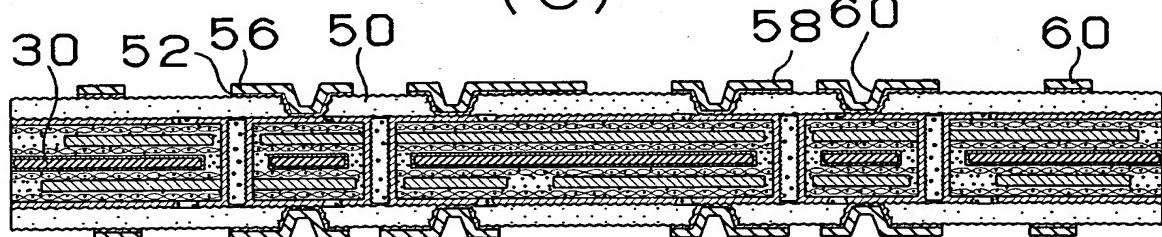
17/29  
Fig. 17  
(A)



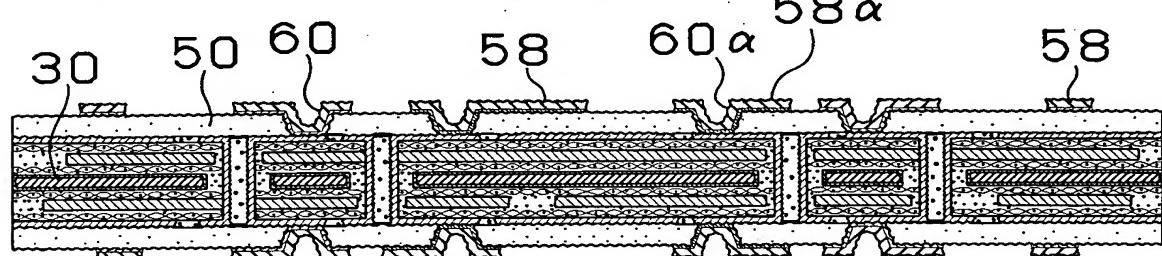
(B)



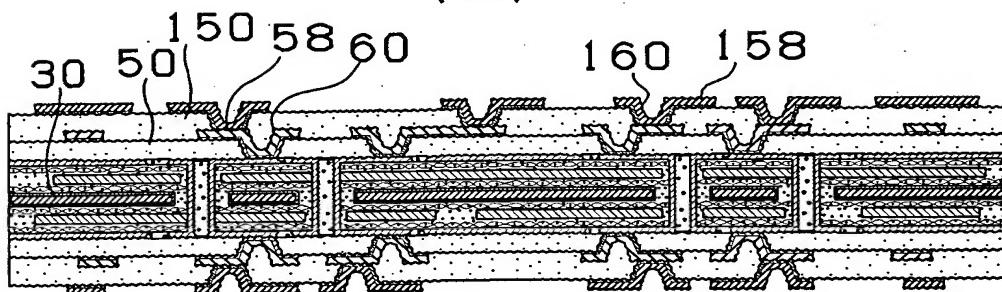
(C)



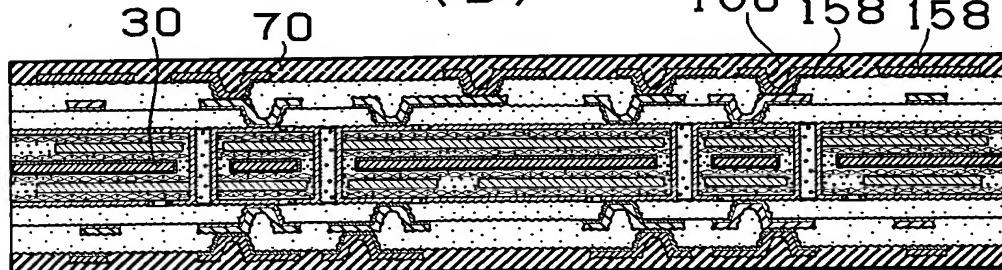
(D)



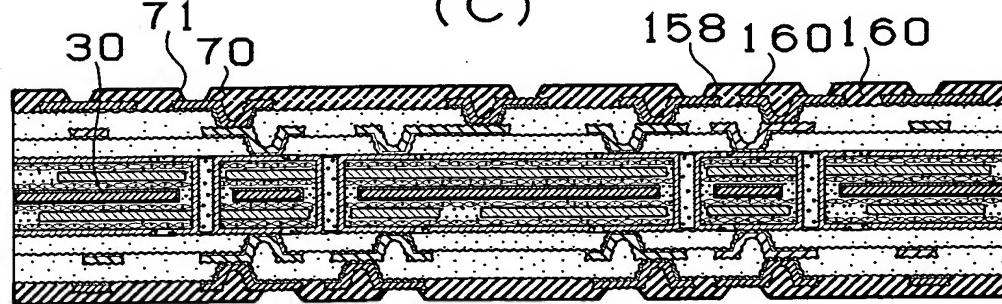
18/29  
Fig. 18  
(A)



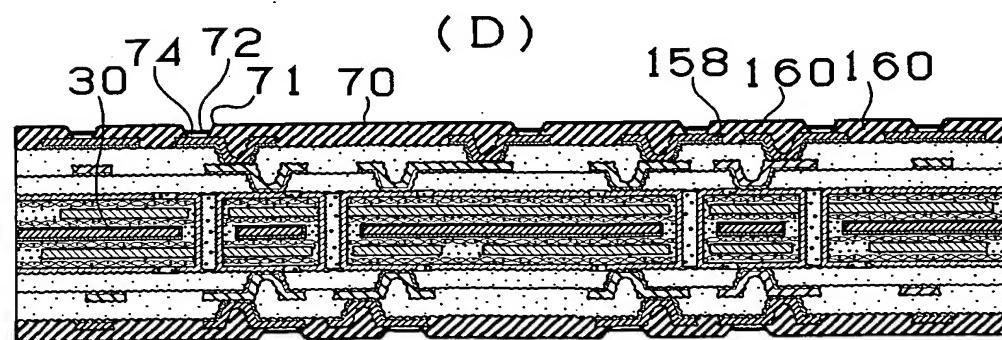
(B)



(C)

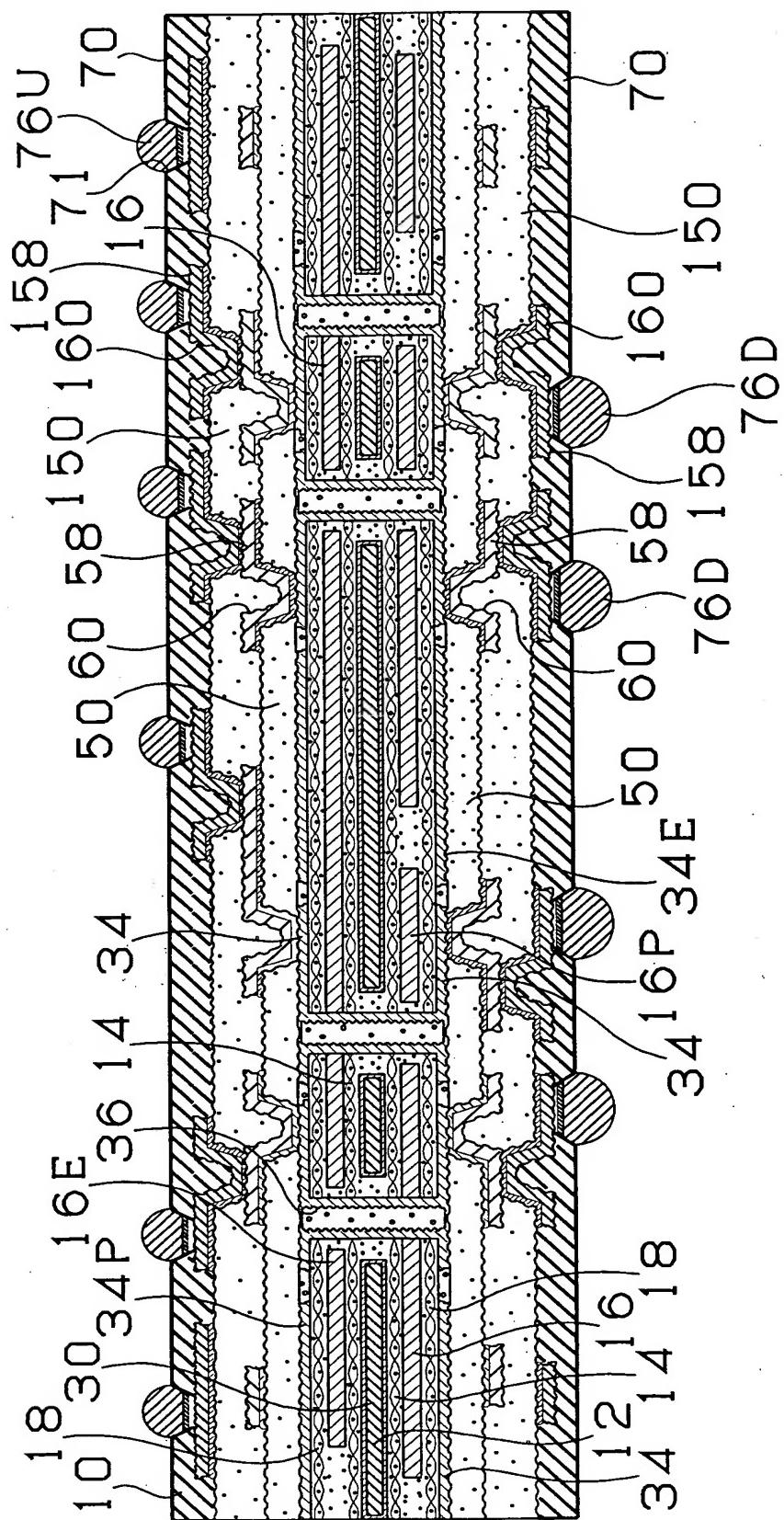


(D)



10/522335

19 / 29



### Fig. 1

20/29

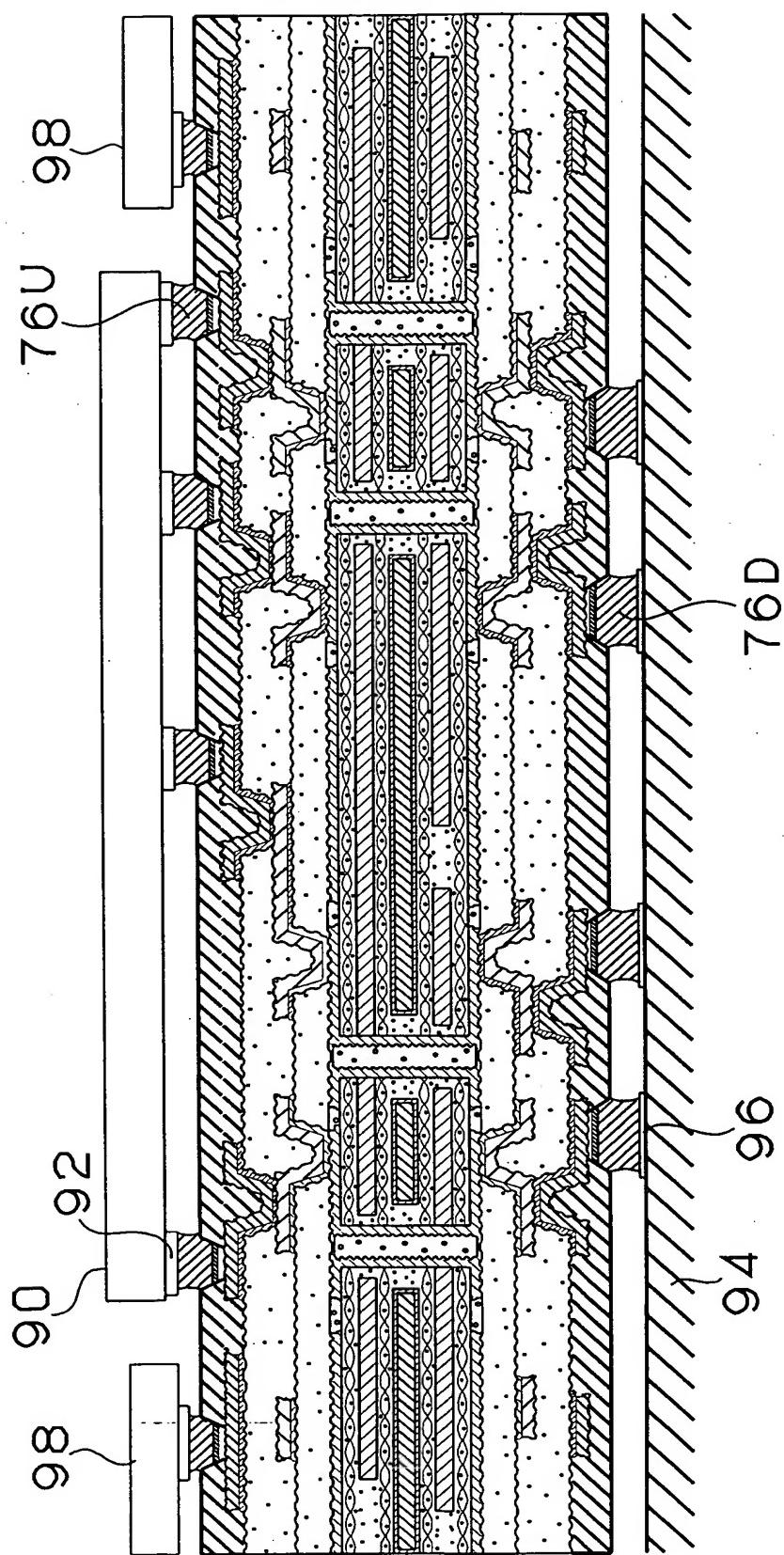
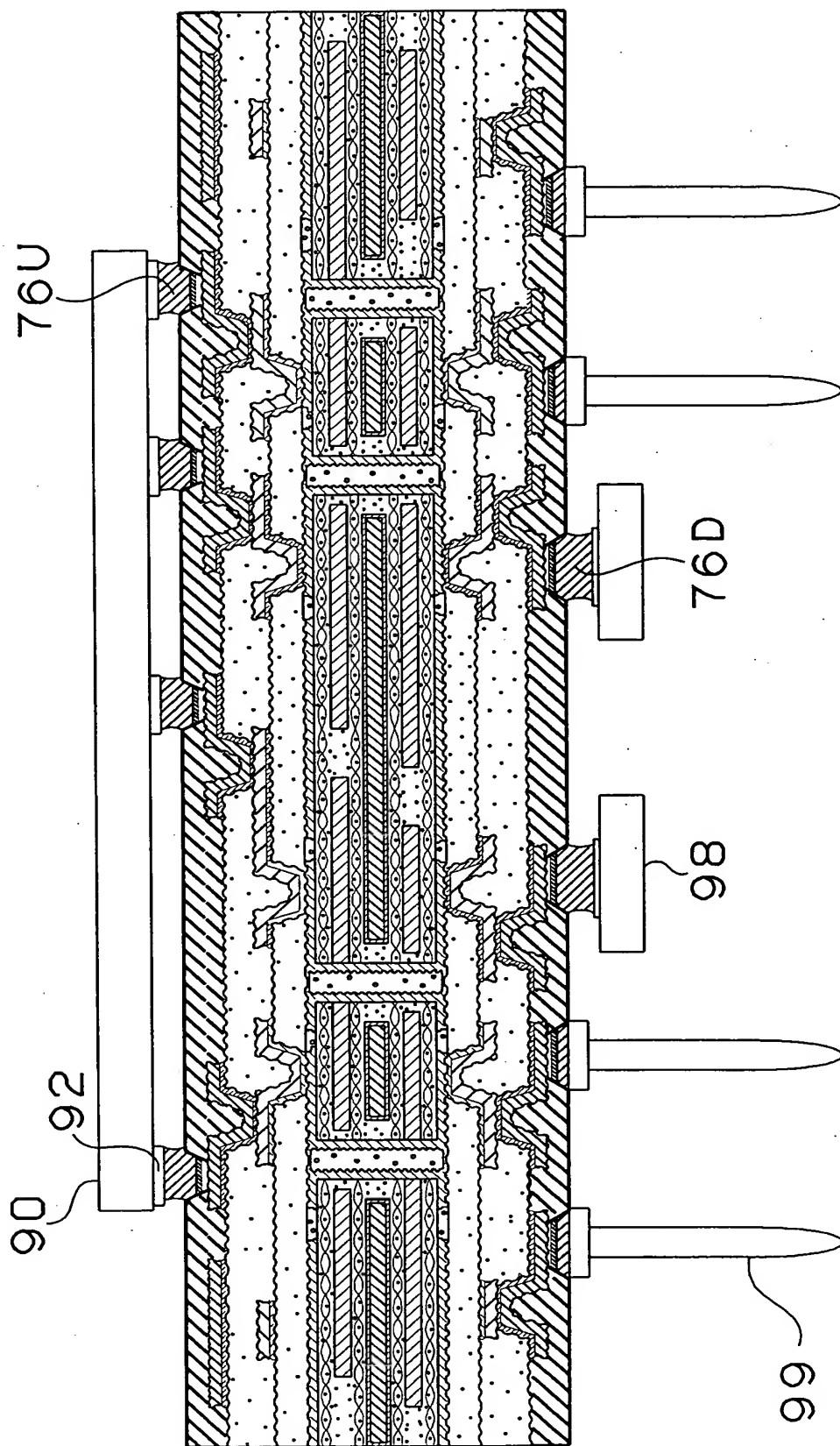


Fig. 20

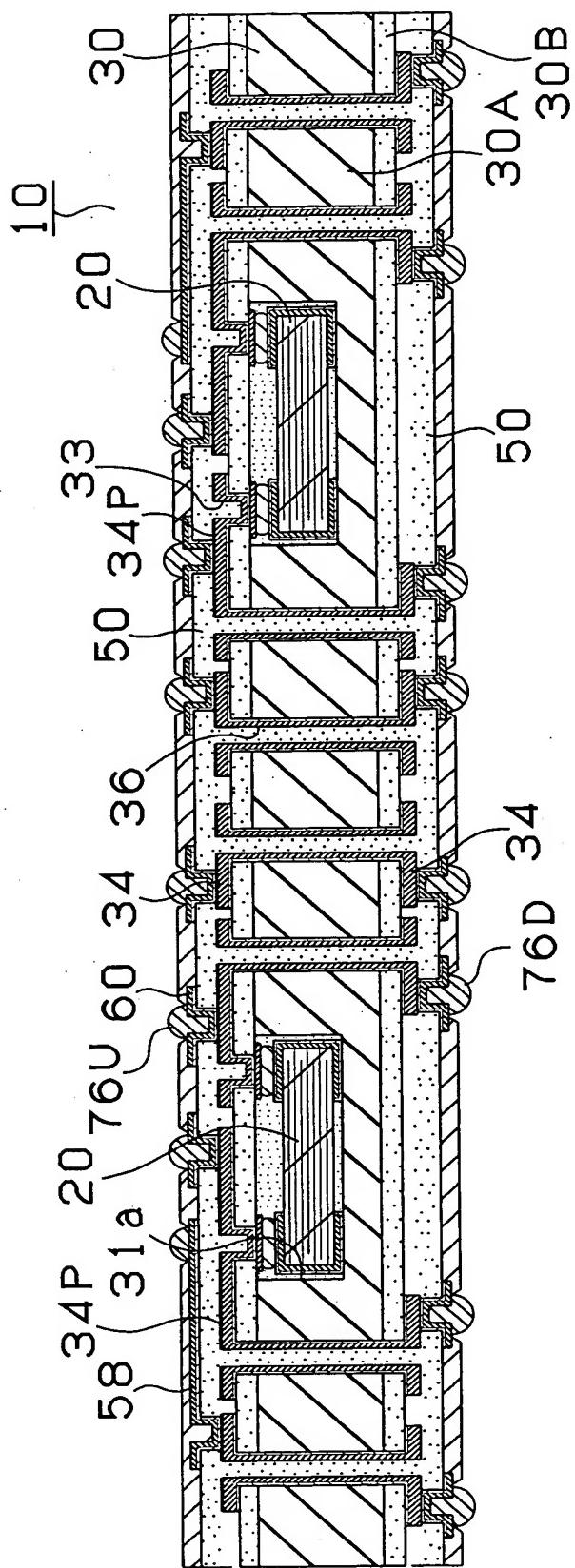
21 / 29

Fig. 21



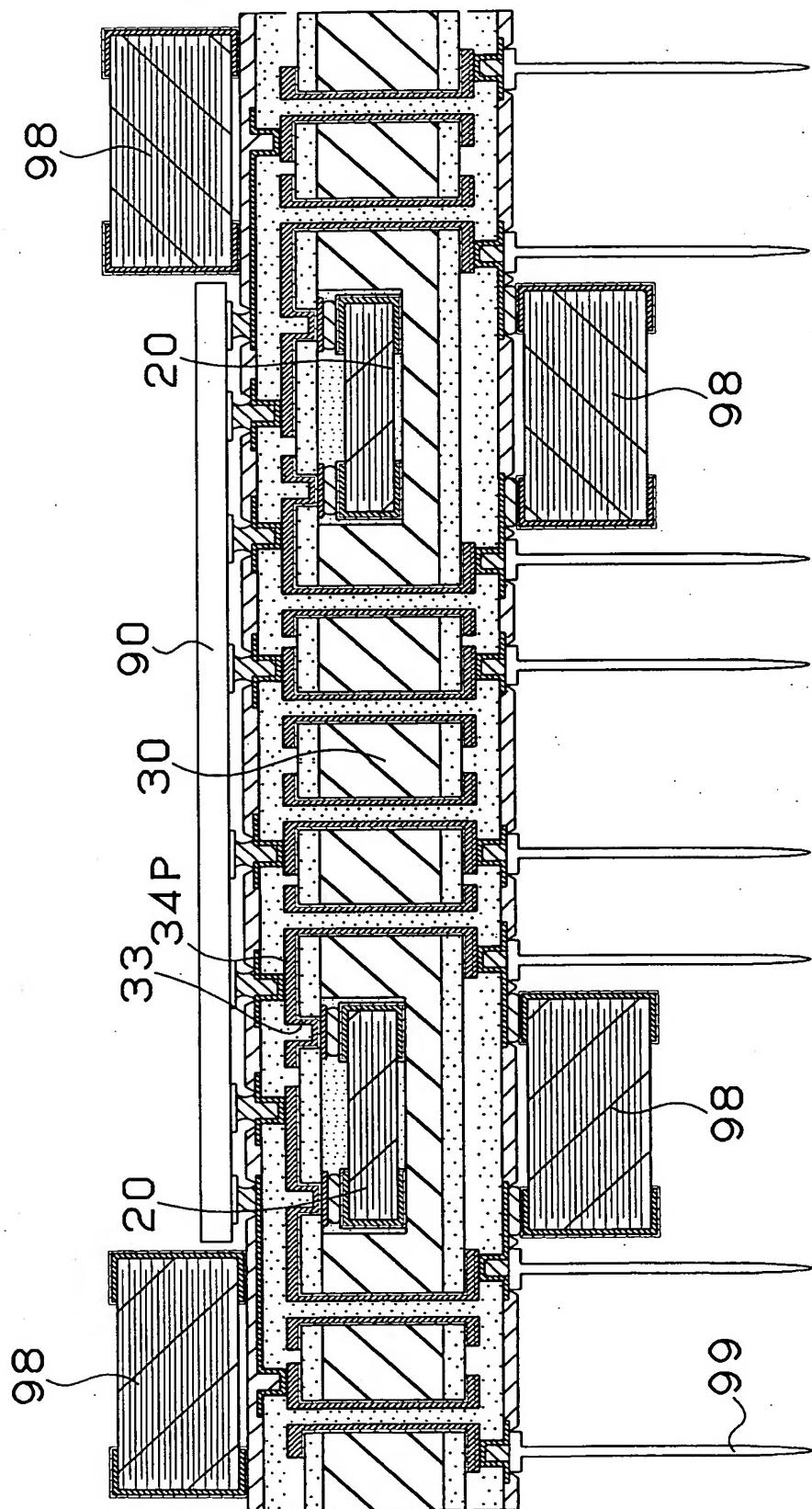
22/29

Fig. 22



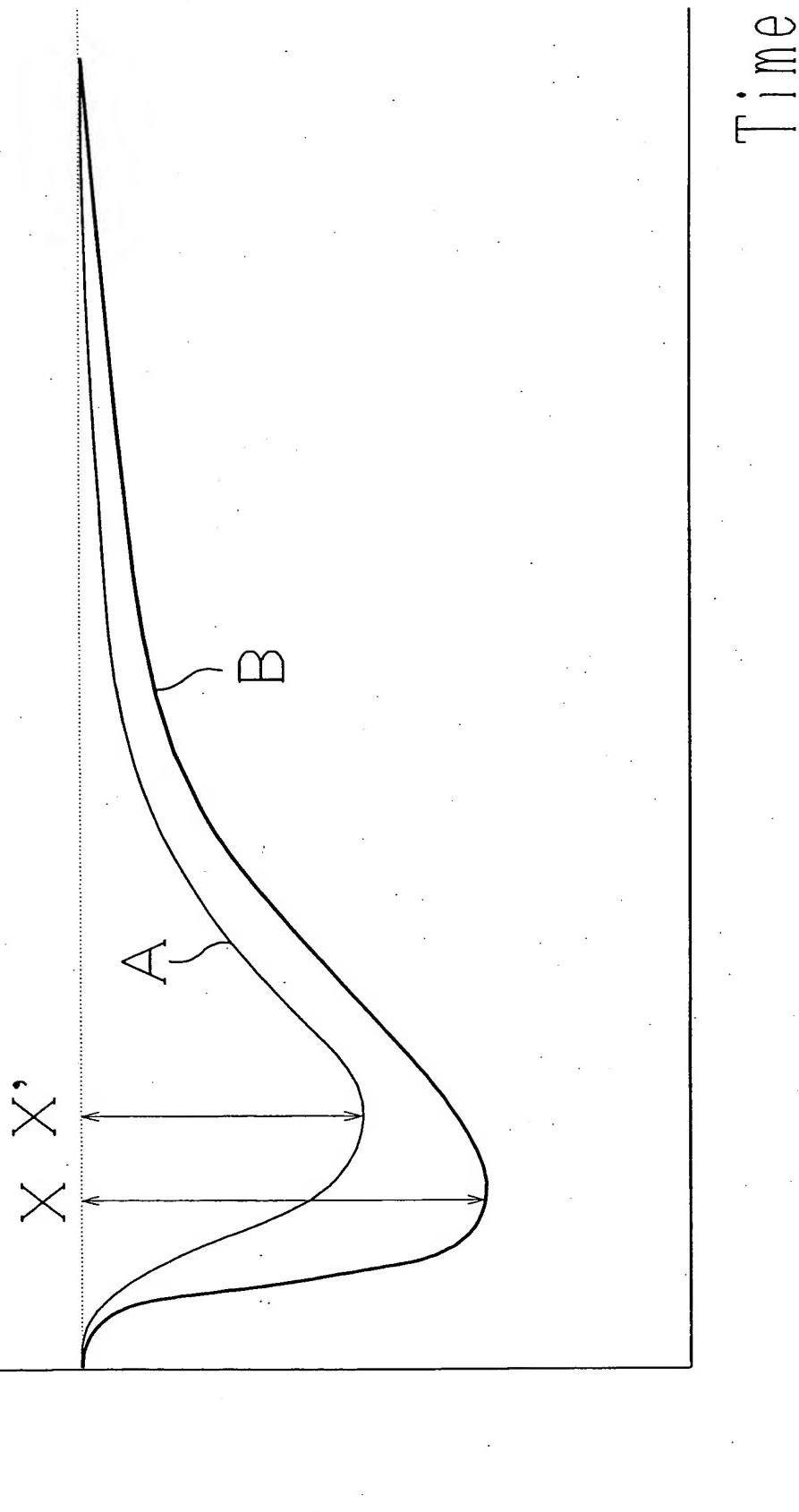
23/29

Fig. 23



24/29

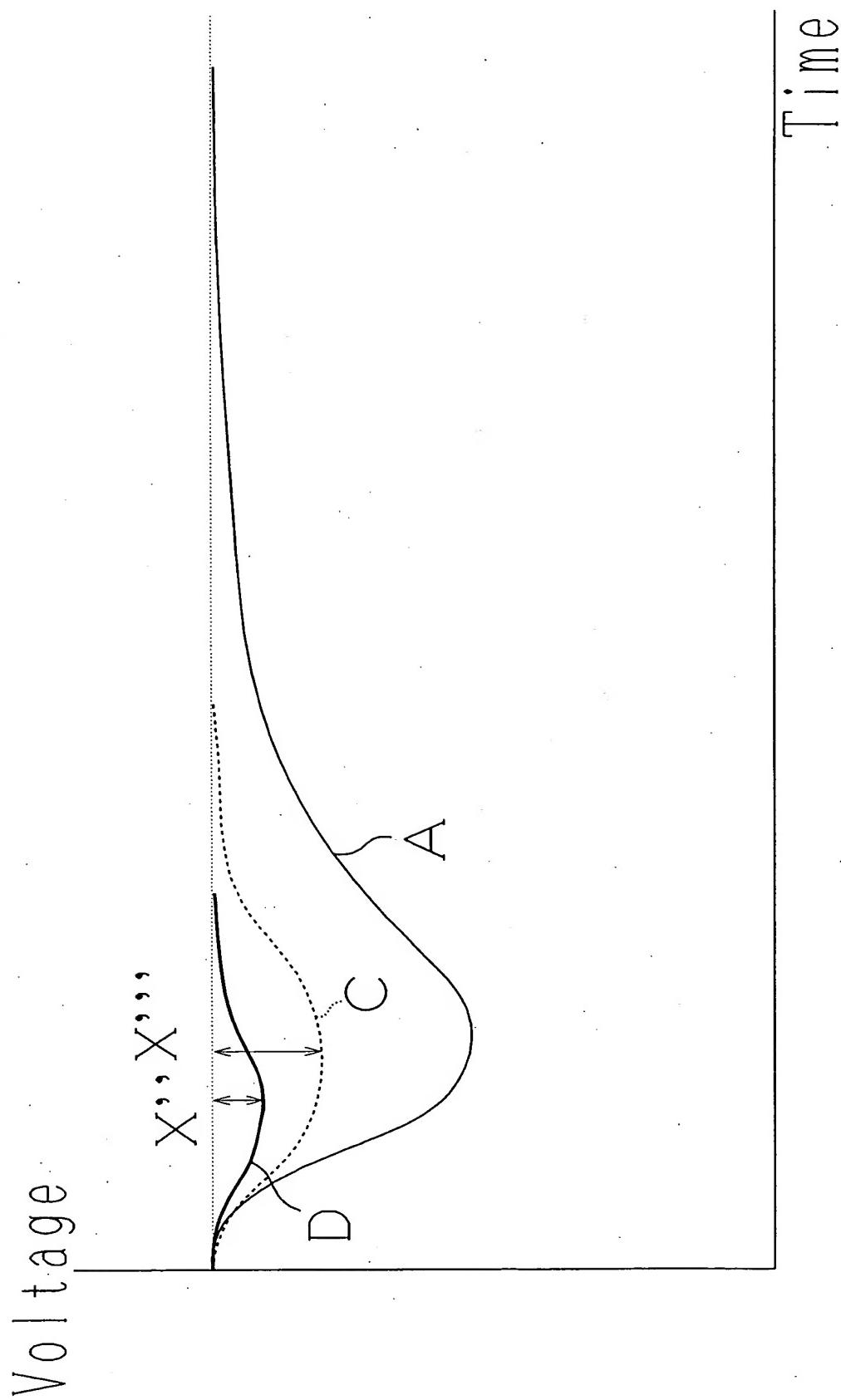
Fig. 24



10/15/2005

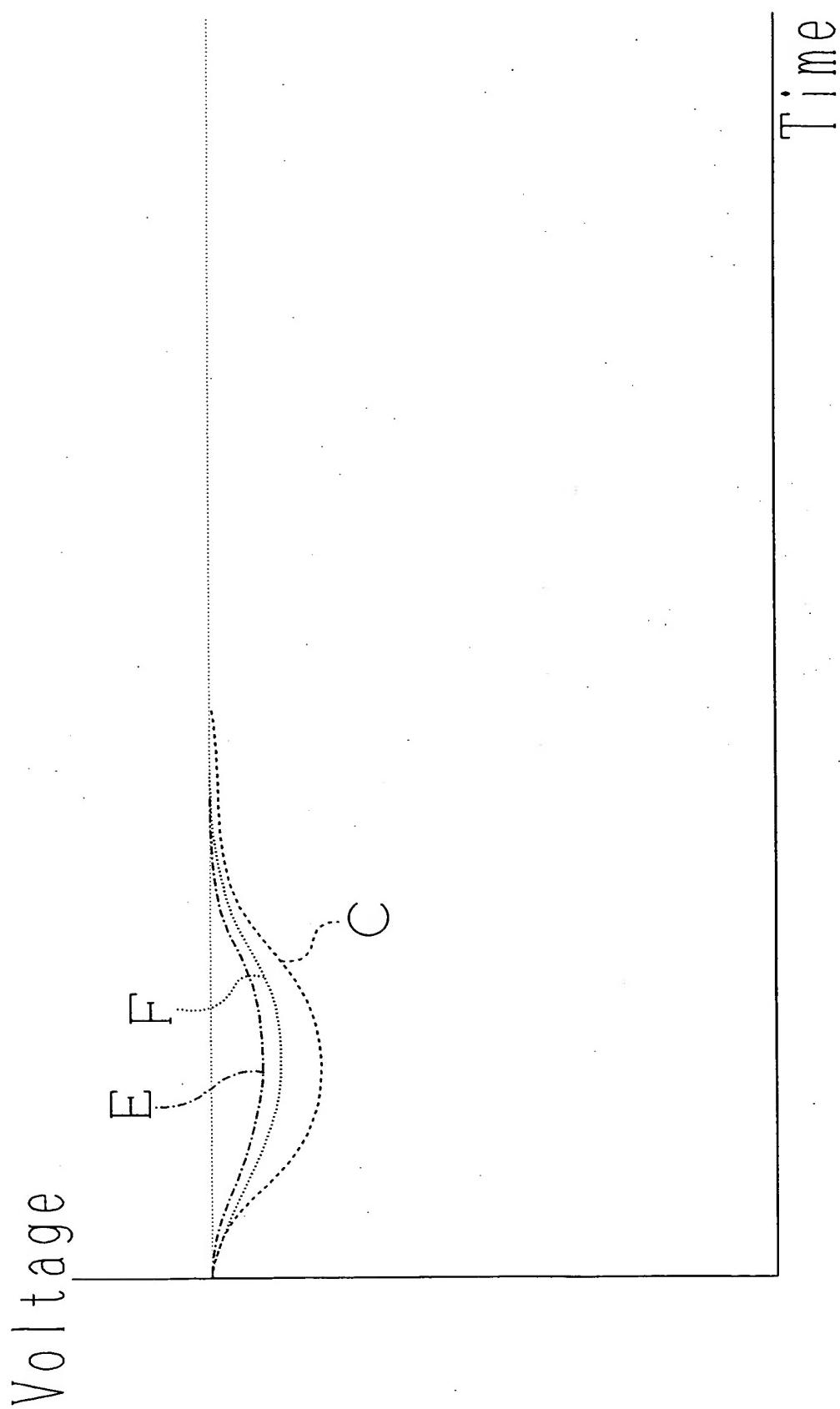
25/29

Fig. 25



26/29

Fig. 26



27 / 29

Fig. 27

	Thickness of Conductor Circuit	1 0 0 h r	3 0 0 h r	5 0 0 h r	1 0 0 0 h r	Voltage Drop Quantity
	Ratio $\alpha_1/\alpha_2$	Presence/Absence of Malfunction of IC	Presence/Absence of Open	Presence/Absence of Malfunction of IC	Presence/Absence of Open	Presence/Absence of Malfunction of IC
Embodiment 1-1	2.0	○	○	○	○	○
Embodiment 1-2	3.7	○	○	○	○	○
Embodiment 1-3	5.0	○	○	○	○	○
Embodiment 1-4	30.0	○	○	○	○	○
Embodiment 1-5	1.2	○	○	○	○	○
Embodiment 2-1	2.0	○	○	○	○	○
Embodiment 2-2	3.7	○	○	○	○	○
Embodiment 2-3	5.0	○	○	○	○	○
Embodiment 2-4	30.0	○	○	○	○	○
Embodiment 3-1	2.3	○	○	○	○	○
Embodiment 3-2	3.7	○	○	○	○	○
Embodiment 3-3	10.0	○	○	○	○	○
Embodiment 3-4	30.0	○	○	○	○	○
Embodiment 3-5	40.0	○	○	○	○	○
Embodiment 4-1	3.3	○	○	○	○	○
Embodiment 4-2	4.0	○	○	○	○	○
Embodiment 4-3	5.0	○	○	○	○	○
Embodiment 4-4	20.0	○	○	○	○	○
Embodiment 4-5	30.0	○	○	○	○	○
Embodiment 4-6	40.0	○	○	○	○	○

28 / 29

Fig. 28

	Thickness of Conductor Circuit	1 0 h r	3 0 0 h r	5 0 0 h r	1 0 0 h r	Voltage Drop Quantity
	Ratio $\alpha_1 / \alpha_2$	Presence/Absence of Malfunction of IC	Presence/Absence of Open	Presence/Absence of Malfunction of IC	Presence/Absence of Open	Presence/Absence of Malfunction of IC
Embodiment 5-1	6.7	○	○	○	○	○
Embodiment 5-2	5.4	○	○	○	○	○
Embodiment 5-3	10.0	○	○	○	○	○
Embodiment 5-4	20.0	○	○	○	○	○
Embodiment 5-5	30.0	○	○	○	○	○
Embodiment 5-6	40.0	○	○	○	○	○
Embodiment 6-1	2.0	○	○	○	○	○
Embodiment 6-2	3.7	○	○	○	○	○
Embodiment 6-3	5.0	○	○	○	○	○
Embodiment 6-4	30.0	○	○	○	○	○
Comparison Example	1.0	×	○	×	×	×
Reference Example	41.5	○	○	○	○	○

Presence/Absence of Malfunction of IC, (○ : No Malfunction; × : Malfunction, Presence/Absence of Open, ○ : No Open, × : Open)

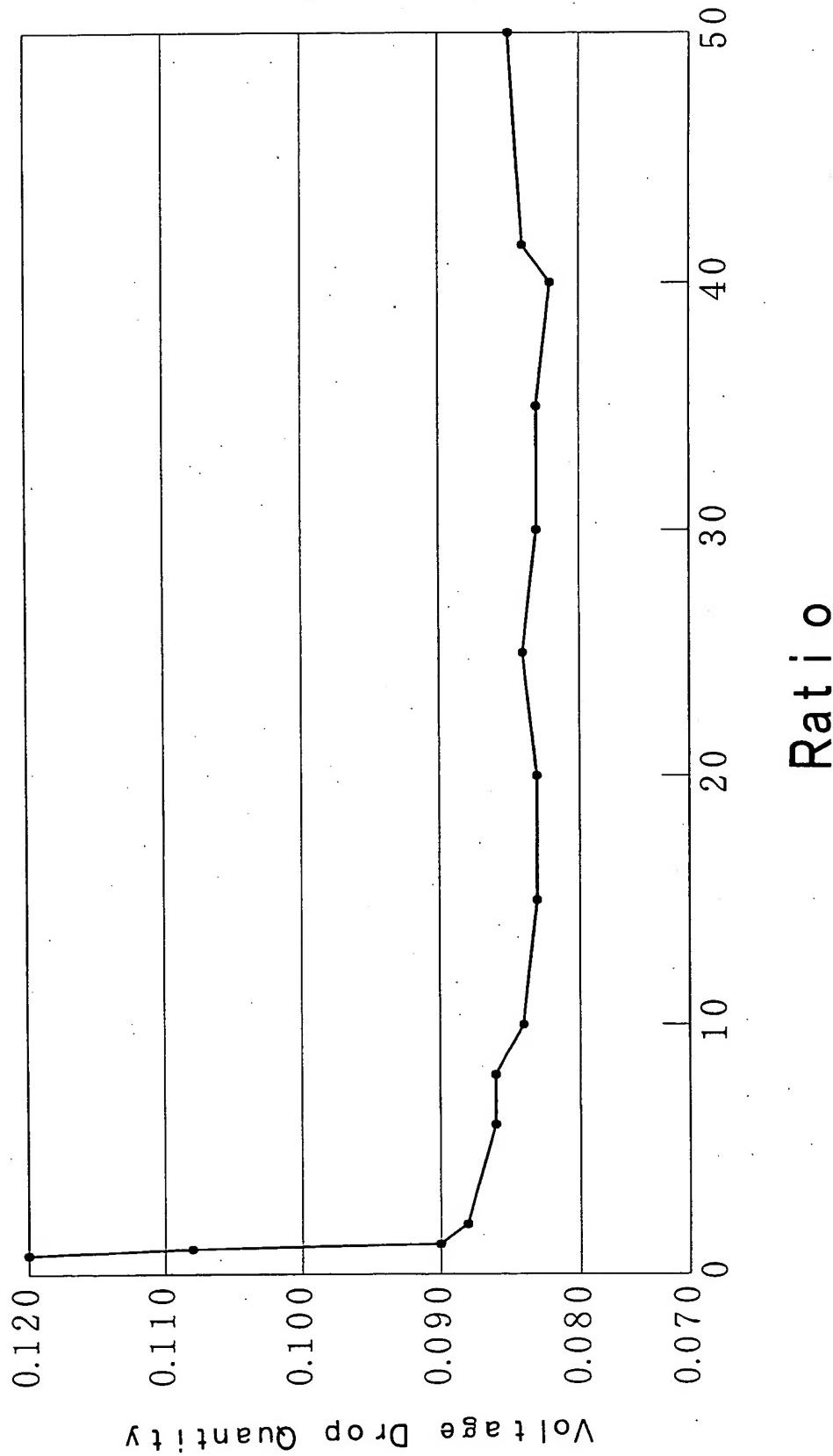
10/1522335

OBLON ET AL (703) 413-3000  
DOCKET # 264533 U.S. SHEET 29 OF 29

29 / 29

Fig. 29

Core Power Supply Layer Ratio



**This Page is Inserted by IFW Indexing and Scanning  
Operations and is not part of the Official Record**

**BEST AVAILABLE IMAGES**

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images include but are not limited to the items checked:

- BLACK BORDERS**
- IMAGE CUT OFF AT TOP, BOTTOM OR SIDES**
- FADED TEXT OR DRAWING**
- BLURRED OR ILLEGIBLE TEXT OR DRAWING**
- SKEWED/SLANTED IMAGES**
- COLOR OR BLACK AND WHITE PHOTOGRAPHS**
- GRAY SCALE DOCUMENTS**
- LINES OR MARKS ON ORIGINAL DOCUMENT**
- REFERENCE(S) OR EXHIBIT(S) SUBMITTED ARE POOR QUALITY**
- OTHER:** \_\_\_\_\_

**IMAGES ARE BEST AVAILABLE COPY.**

**As rescanning these documents will not correct the image problems checked, please do not report these problems to the IFW Image Problem Mailbox.**